TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSIII)

SSM6N24TU

High Speed Switching Applications

Optimum for high-density mounting in small packages

Low on-resistance: $R_{on} = 145 m\Omega \text{ (max) } (@V_{GS} = 4.5 \text{ V})$

 $R_{on} = 180 \text{m}\Omega \text{ (max) (@V_{GS} = 2.5 V)}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V_{DS}	30	V	
Gate-Source voltage		V _{GSS}	± 12	V	
Drain current	DC	ΙD	0.5	Α	
	Pulse	I _{DP}	1.5		
Drain power dissipation		P _D (Note 1)	500	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling

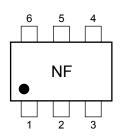
Precautions" "Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

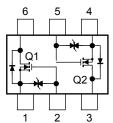
Note 1: Mounted on FR4 board. (total dissipation)

$(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ t}, \text{ Cu Pad: } 645 \text{ mm}^2)$

Marking

Equivalent Circuit (top view)

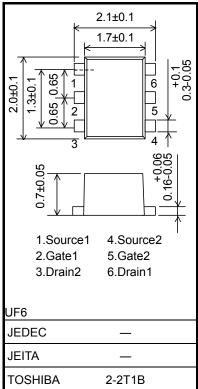




Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Unit: mm



Weight: 7.0 mg (typ.)

Start of commercial production 2004-01

Electrical Characteristics (Ta = 25°C)

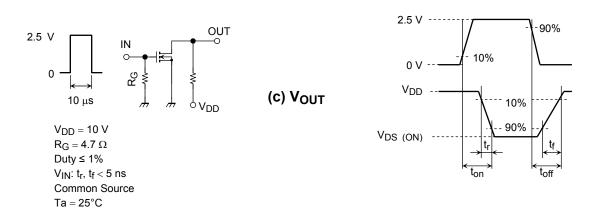
Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage curr	rent	I _{GSS}	$V_{GS} = \pm 12 V, V_{DS} = 0$	_	_	±1	μА	
Drain-Source breakdown voltage		V (BR) DSS	$I_D = 1$ mA, $V_{GS} = 0$	30	_	_	- V	
		V (BR) DSX	$I_D = 1 \text{ mA}, V_{GS} = -12 \text{ V}$	18	_	_		
Drain cut-off curre	ent	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0	_	_	1	μА	
Gate threshold vo	ltage	V _{th}	$V_{DS} = 3 \text{ V}, I_{D} = 0.1 \text{ mA}$	0.5	_	1.1	V	
Forward transfer admittance		Y _{fs}	$V_{DS} = 3 \text{ V}, I_D = 0.25 \text{ A}$ (Note2)	1.0	2.0	_	S	
Drain-Source on-resistance		R _{DS} (ON)	$I_D = 0.50 \text{ A}, V_{GS} = 4.5 \text{ V}$ (Note2)	_	120	145	- mΩ	
			I _D = 0.25 A, V _{GS} = 2.5 V (Note2)	_	140	180		
Input capacitance	pacitance C_{iss} $V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		_	245	_	pF		
Reverse transfer	se transfer capacitance C_{rss} $V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		_	33	_	pF		
Output capacitance		Coss	V _{DS} = 10 V, V _{GS} = 0, f = 1 MHz	_	41	_	pF	
Switching time	Turn-on time	t _{on}	V _{DD} = 10 V, I _D = 0.25 A,	_	9	_	- ns	
	Turn-off time	t _{off}	$V_{GS} = 0 \sim 2.5 \text{ V}, R_G = 4.7 \Omega$	_	15	_		

Note2: Pulse test

Switching Time Test Circuit





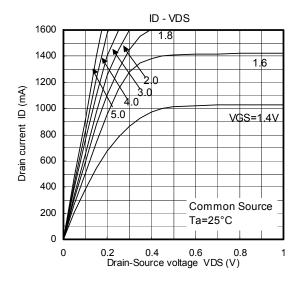


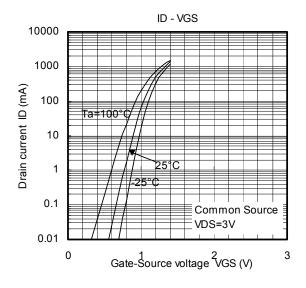
Precaution

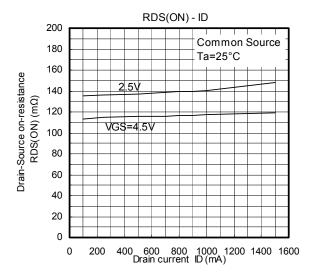
 V_{th} can be expressed as the voltage between gate and source when the low operating current value is I_D =100 μA for this product. For normal switching operation, V_{GS} (on) requires a higher voltage than V_{th} and V_{GS} (off) requires a lower voltage than V_{th} .

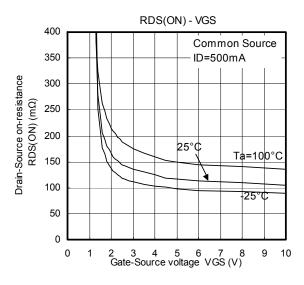
(The relationship can be established as follows: $V_{GS\ (off)}$ < V_{th} < $V_{GS\ (on)}$)

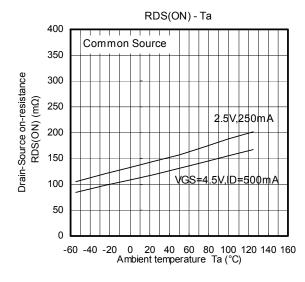
Please take this into consideration when using the device.

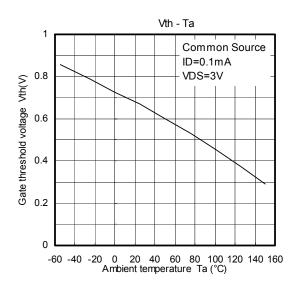


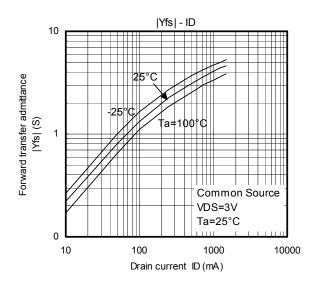


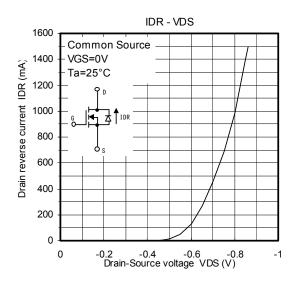


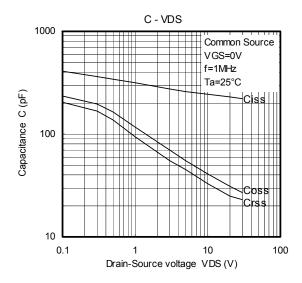


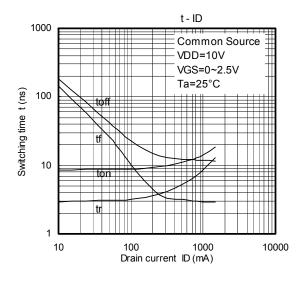


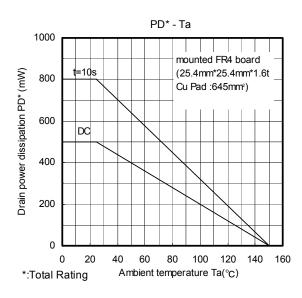


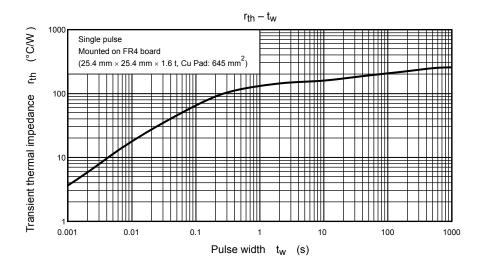












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